



SMT Inductors

Z-transponder coils, size 7.7 x 7.4 x 2.65 mm

Series/Type: B82451L*E402

Ordering code:

Date: 2026-06-22

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Z-transponder coils, size 7.7 x 7.4 x 2.65 mm

B82451L*E402

Rated inductance 1.0 ... 10 mH

Sensitivity 7 ... 23 mV/μT



Construction

- Ferrite core
- Injection moulded base
- Winding laser welded to terminals

Features

- Ruggedized design to pass drop testing
- AEC-Q200 qualified
- Suitable for lead-free reflow soldering
- RoHS-compatible

Applications

- Car access system PEPS (Passive Entry, Passive Start)
- RFID (radio-frequency identification) systems at 125 kHz

Terminals

- Base material CuSn6
- Plating: annealed Sn

Marking

- Marking on component:
L value in nH, "E402", date of manufacture (YWWD)
- Minimum data on reel:
Manufacturer, L value, ordering code, quantity, date of packing

Delivery mode and packing unit

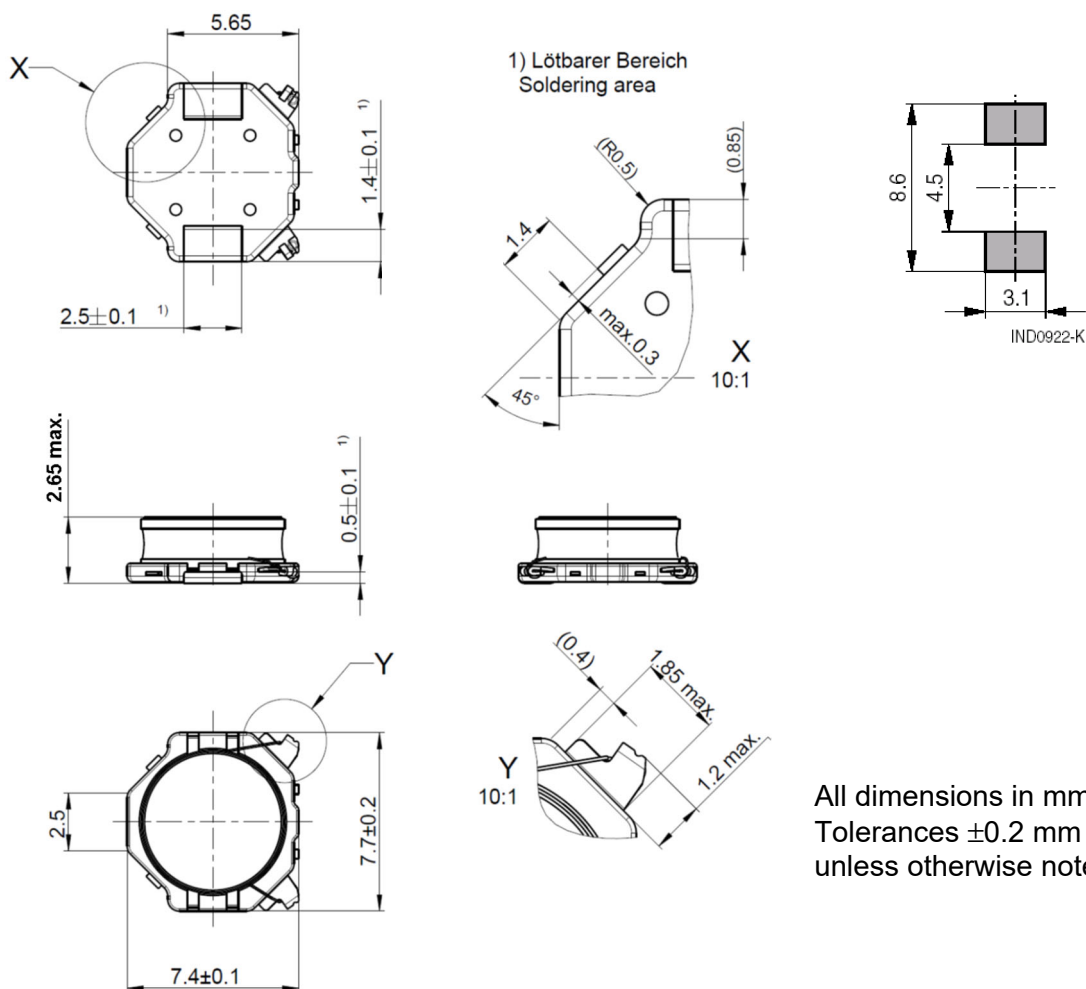
- 16-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 1500 pcs./reel

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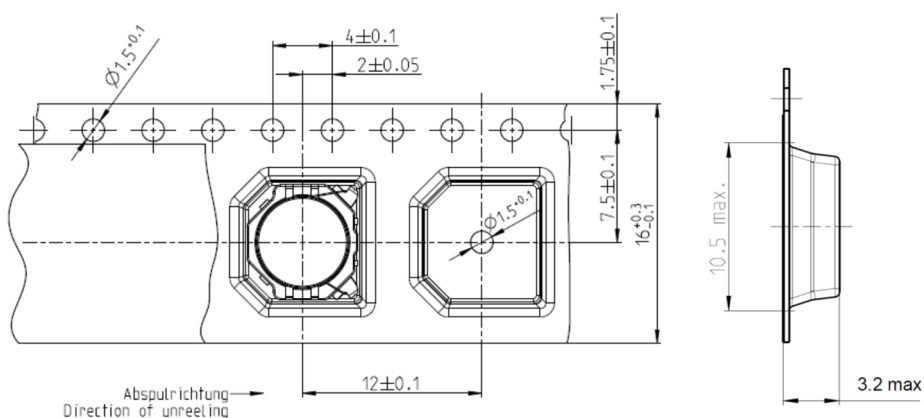
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Dimensional drawing and layout recommendation



Taping



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Technical data and measuring conditions

Rated inductance L_R and tolerance	Measured with LCR meter Agilent 4284A at frequency f_L , 0.5 V, +20 °C
Q factor Q_{min}	Measured with Agilent 4294A at frequency f_Q , RMS voltage 500 mV, +20 °C
Sensitivity S_{typ}	Measured with Helmholtz coil test setup at 125 kHz
Self resonance frequency $f_{res,typ}$	Measured with HP8753
DC resistance R_{typ}	Measured at +20 °C
Solderability (lead-free)	Dip and look method Sn95.5Ag3.8Cu0.7: +(245 ±5) °C, (3 ±0.3) s Wetting of soldering area ≥ 90% (based on IEC 60068-2-58)
Resistance to soldering heat	+260 °C, 40 s (as referenced in JEDEC J-STD-020)
Operating temperature range	-40 °C to 85 °C (including self-temperature rise)
Inductance drift over operating temperature range and after 3 reflow cycles and life tests (2000hrs @125°C, 2000 Thermal Shocks, 2000hrs 85°C/85%r.h.)	< ±3%, reference temperature +20 °C
Climatic category	40/85/56 (to IEC 60068-1)
Storage conditions	Mounted: -55 °C ... +85 °C Packaged: -25 °C ... +40 °C, ≤ 75% RH
Weight	Approx. 1.0 g

Characteristics and ordering codes

L_R mH	Tolerance	f_L, f_Q, f_S kHz	Q_{typ} (±20%)	S_{typ} (±20%) mV/μT	$f_{res,typ}$ (±20%) MHz	R_{typ} (±20%) Ω	Ordering code
1.0	±3%	125	55	7	3.0	9.0	B82451L1004E402
2.36			55	11	2.2	20.0	B82451L2364E402
4.66			58	16	1.2	38.5	B82451L4664E402
4.75			58	16	1.2	40.3	B82451L4754E402
4.81			58	16	1.2	40.7	B82451L4814E402
7.8			50	20	0.90	84.5	B82451L7804E402
10.0			50	23	0.85	104.0	B82451L1005E402

Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets.
 - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
 - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pins only. Temperatures specified in relation to reflow soldering can also refer to the pins or terminals for products with larger thermal mass, as in such cases, the temperature difference to the top of the component is too big (e.g., high proportion of core within the component).
- If the components are to be washed or varnished it is necessary to check whether the washing or varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing or varnish agent residues to have a negative effect in the long-term on wire insulation.
Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
 - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting, sealing, or varnishing materials used attack or destroy the wire, wire insulation, plastics or glue.
 - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
 - Many coating materials have a negative effect (chemically and mechanically) on the winding wires, insulation materials and connecting points. Customers are always obliged to determine whether and to what extent their coating materials influence the component. Customers are responsible and bear all risk for the use of the coating material. TDK Electronics does not assume any liability for failures of our components that are caused by the coating material.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.

Cautions and warnings

- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
 - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
 - If additional mechanical forces are applied to the component, e.g., application of gap pads, it is necessary to check whether they attack or destroy any part of the component.
 - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Due to product design and applied manufacturing process, appearance, symmetry, and shape of not dimensioned details could vary within same lot, as well discoloration of housing is possible. TDK does not expect detrimental effects on product function or reliability. In case of conflicts, TDK reference standard shall prevail.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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3. **The warnings, cautions and product-specific notes must be observed.**
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We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

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Important notes

8. The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, FilterCap, FormFit, InsuGate, LeaXield, MediPlas, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PiezoBrush, PlasmaBrush, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SurfIND, ThermoFuse, WindCap, XieldCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

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